# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
Chia-Wei Wu	06/01/2006
Jung-Yu Shieh	06/01/2006
Ling Wuu Yang	06/01/2006

## **RECEIVING PARTY DATA**

Name:	Macronix International Co., Ltd.	
Street Address:	No. 16, Li-Hsin Road	
Internal Address:	Science-Based Industrial Park	
City:	Hsinchu	
State/Country:	TAIWAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11423859

## **CORRESPONDENCE DATA**

Fax Number: (214)978-3099

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Email: scarlett.k.pereida@bakernet.com

Correspondent Name: Noel C. Gillespie

Address Line 1: 2001 Ross Avenue, Suite 2300

Address Line 2: Baker & McKenzie LLP
Address Line 4: Dallas, TEXAS 75201

ATTORNEY DOCKET NUMBER:	87092291.672181
NAME OF SUBMITTER:	Noel C. Gillespie

Total Attachments: 3

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# **ASSIGNMENT**

WHEREAS, we, the undersigned inventors of residences as listed, have invented certain new and useful improvements as below entitled, for which an application for United States Letters Patent is made, said applications having been designated as set forth below and filed on or about the date set forth below; and

WHEREAS, Macronix International Co., Ltd. (hereinafter referred to as "Assignee"),

a Taiwan, R.O.C. corporation

with an address of:

No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

desires to acquire the entire right, title and interest in and to the inventions, and in and to the said application and any Letters Patent(s) that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we assign to Assignee, all right, title and interest in and to said inventions and in and to said applications and all patents which may be granted therefor, and all divisions, reissues, continuations, continuations-in-part and extensions thereof; and we authorize and request the Commissioner of Patents and Trademarks to issue all patents for said inventions, or patents resulting therefrom, insofar as our interest is concerned, to Assignee.

We also assign to Assignee, all right, title and interest in and to the invention disclosed in said applications throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world, including all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such right, title and interest in Assignee.

We will communicate to Assignee any facts known to us respecting any improvements; and, at the expense of Assignee, we will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, make lawful oaths and declarations, and generally do everything possible to vest title in Assignee and to aid Assignee to obtain and enforce proper protection for said invention in all countries.

This Assignment shall be binding on the parties' successors, assigns and legal representatives.

Invention Name:

METHODS FOR FORMING AN ISOLATION STRUCTURE IN A

SILICON SUBSTRATE

Date Filed:

Serial Number:

We hereby grant NOEL C. GILLESPIE, Registration No. 47,596, HOWARD N. WISNIA, Registration No. 37,502, LESTER J. ANDERSON, Registration No. 45,833, DAVID B. KOO, Registration No. 46,839, JAMES P. CONLEY, Registration No. 52,459, PAMELA J. WONG, Registration No. 54,765, JOHN G. FLAIM, Registration No. 37,323, BRIAN C. McCORMACK, Registration No. 36,601, WILLIAM D. McSPADDEN, Registration No. 44,234, JAMES H. ORTEGA, Registration No. 50,554, RICHARD V. WELLS, Registration No. 53,757 and LAURENCE KAO, Registration No. 56,387 and all attorneys with the firm of Baker & McKenzie (Customer Number 23562) with an office at 2001 Ross Avenue, Suite 2300, Dallas, TX 75201, the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

The undersigned further declares that all statements made herein of his/her own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful and false statements may jeopardize the validity of the application or any patent issued thereon.

Signature of Inventor:	Chia Wei Wn
Inventor(s) Name:	Chia-Wei Wu
Residence:	No. 13, Alley 5, Lane 31, Wunming Road, Houli Township, Taichung County 421, Taiwan R.O.C.
Citizenship:	Taiwan, R.O.C.
Date:	6/1 / >006
Signature of Inventor:	Jung-Yn shiph
Inventor(s) Name:	Jung-Yu Shieh
Residence:	3F., No. 49, Lane 27, Zihyou Road, Hsinchu City 300, Taiwan R.O.C.
Citizenship:	Taiwan, R.O.C.
	Zurrung Rio.C.

Signature of Inventor:

Inventor(s) Name:

**RECORDED: 06/13/2006** 

Ling Wuu Yang

Residence:

12F.-1, No. 2, Lane 175, Wuling Road, Hsinchu City 300,

Taiwan R.O.C.

Citizenship:

Taiwan, R.O.C.

Date:

2006/6/1